**New Product** 



### SE07PB thru SE07PJ

Vishay General Semiconductor

# **Surface Mount ESD Capability Rectifiers**



DO-220AA (SMP)

PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	0.7 A				
V <sub>RRM</sub>	100 V to 600 V				
I <sub>R</sub>	5 μΑ				
V <sub>F</sub> at I <sub>F</sub> = 0.7 A	0.865 V				
T <sub>J</sub> max.	175 °C				

#### **TYPICAL APPLICATIONS**

General purpose, polarity protection, and rail-to-rail protection in both consumer and automotive applications.

### FEATURES

- Very low profile typical height of 1.0 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop
- Typical I<sub>B</sub> less than 0.1 μA
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21
  definition

#### **MECHANICAL DATA**

Case: DO-220AA (SMP)

Molding compound meets UL 94 V-0 flammability rating.

Base P/N-M3 - halogen-free and RoHS compliant, commercial grade

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test **Polarity:** Color band denotes the cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	SE07PB	SE07PD	SE07PG	SE07PJ	UNIT
Device marking code		07B	07D	07G	07J	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	100	200	400	600	V
Average forward current (fig. 1)	I <sub>F(AV)</sub>	0.7			А	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	20			А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	- 55 to + 175				°C

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25 \degree C$ , unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Maximum instantaneous forward voltage <sup>(1)</sup>	I <sub>F</sub> = 0.7 A I <sub>F</sub> = 0.7 A	T <sub>J</sub> = 25 °C T <sub>J</sub> = 125 °C	V <sub>F</sub>	0.965 0.865	1.05 0.95	V	
Maximum reverse current <sup>(2)</sup>	rated V <sub>R</sub>	T <sub>J</sub> = 25 °C T <sub>J</sub> = 125 °C	I <sub>R</sub>	- 3.7	5.0 50	μΑ	
Typical junction capacitance time	4.0 V, 1 M⊦	lz	CJ	5.0	-	pF	

Notes:

 $^{(1)}$  Pulse test: 300  $\mu$ s pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: Pulse width  $\leq$  40 ms



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<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ , unless otherwise noted)						
PARAMETER      SYMBOL      SE07PB      SE07PG      SE07PJ      UN						UNIT
Typical thermal resistance <sup>(1)</sup>	R <sub>θJA</sub> R <sub>θJL</sub> R <sub>θJC</sub>	105 25 30			°C/W	

Note:

<sup>(1)</sup> Thermal resistance from junction to ambient and junction to lead mounted on P.C.B. with 5.0 mm x 5.0 mm copper pad areas.  $R_{\theta JL}$  is measured at the terminal of cathode band.  $R_{\theta JC}$  is measured at the top center of the body

<b>IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS</b> $(T_A = 25 \text{ °C}, \text{ unless otherwise noted})$						
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE	
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 k $\Omega$		H3B	> 8 kV	
AEC-Q101-002	Machine model (contact mode)	C = 200 pF, R = 0 $\Omega$		M4	> 400 V	
JESD22-A114	Human body model (contact mode)	C = 150 pF, R = 1.5 k $\Omega$	V	3B	> 8 kV	
JESD22-A115	Machine model (contact mode)	C = 200 pF, R = 0 $\Omega$	V <sub>C</sub>	С	> 400 V	
IEC 61000-4-2 <sup>(2)</sup>	Human body model (contact mode)	C = 150 pF, R = 150 $\Omega$		4	> 8 kV	
120 01000-4-2 ( )	Human body model (air-discharge mode) <sup>(1)</sup>	C = 150 pF, R = 150 $\Omega$		4	> 15 kV	

Notes:

<sup>(1)</sup> Immunity to IEC 61000-4-2 air discharge mode has a typical performance > 30 kV

(2) System ESD standard

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
SE07PJ-M3/84A	0.024	84A	3000	7" diameter plastic tape and reel		
SE07PJ-M3/85A	0.024	85A	10 000	13" diameter plastic tape and reel		

#### **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25 °C unless otherwise noted)

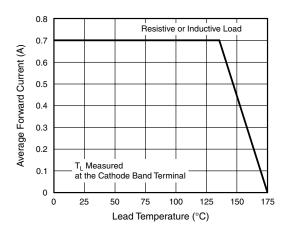


Figure 1. Maximum Forward Current Derating Curve

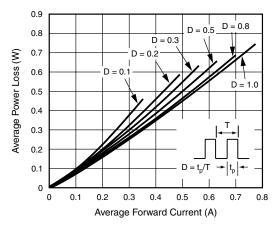


Figure 2. Forward Power Loss Characteristics





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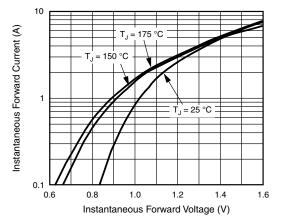


Figure 3. Typical Instantaneous Forward Characteristics

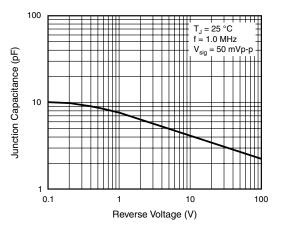


Figure 5. Typical Junction Capacitance

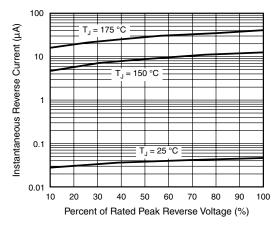
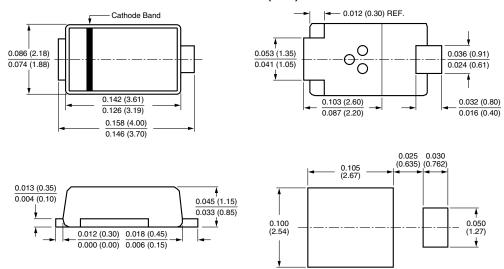


Figure 4. Typical Reverse Leakage Characteristics







For technical questions within your region, please contact one of the following: PDD-Americas@vishay.com, PDD-Asia@vishay.com, PDD-Europe@vishay.com



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